

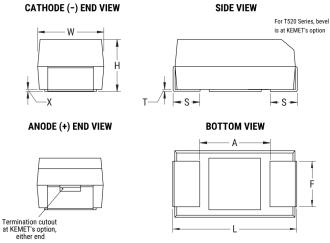
T520

Polymer Tantalum

68 uF

20%

T520, Tantalum, Polymer Tantalum, 68 uF, 20%, 6.3 VDC, SMD, Polymer, Molded, Low Profile/ESR, NonCombustible, 70 mOhms, 6032, Height Max =  $\frac{1}{2}$ 



H X		Style	SMD Chip
	T	Description	SMD, Polymer, Molded, Low Profile/ESR, NonCombustible
		Features	Low ESR
ANODE (+) END VIEW	BOTTOM VIEW	RoHS	No
Termination cutout at KEMET's option, either end  Click here for the 3D model.	A	Prop 65	▲ WARNING: Cancer and reproductive harm - http://www.p65warnings.ca.gov.
		SCIP Number	b064b03e-bd75-42af-b342-1fe94dec2340
	F	Termination	Solder Coated
		AEC-Q200	No
		Component Weight	117.36 mg
		Shelf Life	52 Weeks
		MSL	3

**Specifications** 

Capacitance Capacitance

General Information

Series

Dielectric

Dimensions	
Footprint	6032
L	6mm +/-0.3mm
W	3.2mm +/-0.2mm
Н	1.4mm +/-0.1mm
Т	0.13mm REF
S	1.3mm +/-0.3mm
F	2.2mm +/-0.1mm
Α	2.9mm MIN
X	0.05mm REF

VV	3.211111 1/ =0.211111	Tolerance	20%
Н	1.4mm +/-0.1mm	Voltage DC	6.3 VDC (105C)
Т	0.13mm REF	3	6.3 VDC (103C)
S	1.3mm +/-0.3mm	Temperature Range	-55/+105°C
F	2.2mm +/-0.1mm	Rated	105°C
A	2.9mm MIN	Temperature	103 C
Χ	0.05mm REF	Life	2000 Hrs (105C)
		Humidity	60C, 90% RH, 500 Hours, No Load
		Dissipation Factor	8% 120Hz 25C
Packaging Specifications		Failure Rate	N/A
Packaging	T&R, 178mm	Resistance	70 mOhms (100kHz 25C)
Packaging Quantity	1000	Ripple Current	1400 mA (rms, 100kHz 45C), 980 mA (rms, 85C), 350 mA (rms, 105C)
		Leakage Current	42.8 uA (5min 25°C)

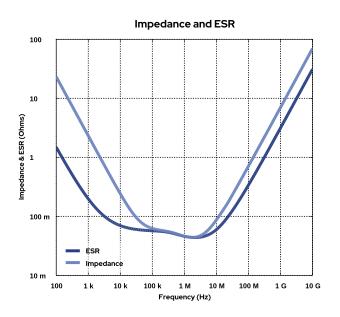
Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

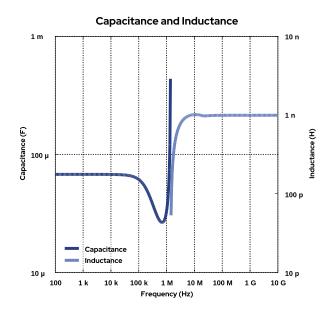


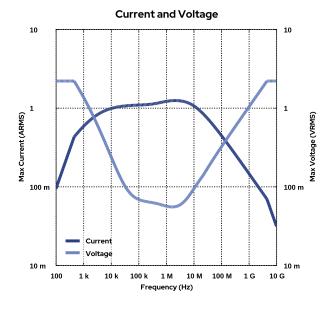
T520, Tantalum, Polymer Tantalum, 68 uF, 20%, 6.3 VDC, SMD, Polymer, Molded, Low Profile/ESR, NonCombustible, 70 mOhms, 6032, Height Max = 15mm

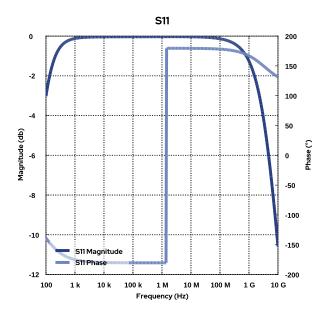
## **Simulations**

For the complete simulation environment please visit K-SIM.



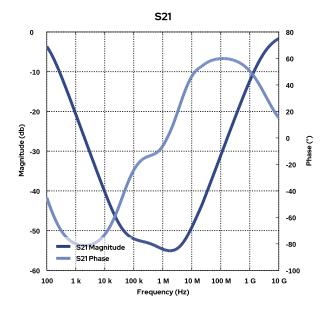








T520, Tantalum, Polymer Tantalum, 68 uF, 20%, 6.3 VDC, SMD, Polymer, Molded, Low Profile/ESR, NonCombustible, 70 mOhms, 6032, Height Max = 1.5mm





T520, Tantalum, Polymer Tantalum, 68 uF, 20%, 6.3 VDC, SMD, Polymer, Molded, Low Profile/ESR, NonCombustible, 70 mOhms, 6032, Height Max =  $\frac{1}{2}$ 

#### These are simulations.

This is not a specification!

The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

The responses shown do not represent a specified or implied maximum capability of the device for all applications.

- The ESR used for ripple "Ripple Current/Voltage vs. Frequency" plots is the ESR at ambient temperature.
- The ESR in the "Temperature Rise vs. Ripple Current" plots is adjusted to each incremental temperature rise before the power and ripple current is calculated.
- The effects shown herein are based on measured data from a multiple part sample of the parts in question.
- Ripple capability of this device will be factored by thermal resistance (Rth) created by circuit traces (addi affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

  The peak voltages generated in the "Temperature Rise vs. Combined Ripple Currents" plot are calculated for each frequency and are not combined with voltages generated at any other
- Please consult with the catalog or field applications engineer for maximum capability of the device in specific applications.

All product information and data (collectively, the "Information") are subject to change without notice.

KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels. The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation effects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

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If you have any questions please contact K-SIM.

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